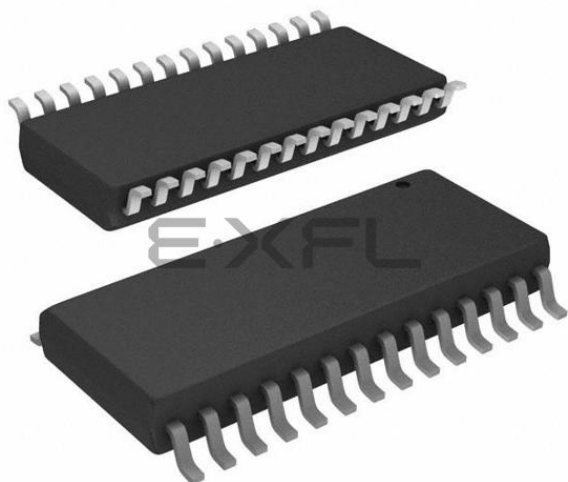




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Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	24
Program Memory Size	16KB (16K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323leh2816c00tr



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Figure 35. Stop Mode Recovery Source	57
Figure 36. Stop Mode Recovery Register 2 ((0F)DH:D2–D4, D6 Write Only) . . .	59
Figure 37. Watch-Dog Timer Mode Register (Write Only)	60
Figure 38. Resets and WDT	61
Figure 39. TC8 Control Register ((0D)00H: Read/Write Except Where Noted) . . .	64
Figure 40. T8 and T16 Common Control Functions ((0D)01H: Read/Write) . . .	65
Figure 41. T16 Control Register ((0D) 2H: Read/Write Except Where Noted) . . .	67
Figure 42. T8/T16 Control Register (0D)03H: Read/Write (Except Where Noted)	68
Figure 43. Voltage Detection Register	69
Figure 44. Port Configuration Register (PCON)(0F)00H: Write Only)	70
Figure 45. Stop Mode Recovery Register ((0F)0BH: D6–D0=Write Only, D7=Read Only)	71
Figure 46. Stop Mode Recovery Register 2 ((0F)0DH:D2–D4, D6 Write Only) . . .	72
Figure 47. Watch-Dog Timer Register ((0F) 0FH: Write Only)	73
Figure 48. Port 2 Mode Register (F6H: Write Only)	73
Figure 49. Port 3 Mode Register (F7H: Write Only)	74
Figure 50. Port 0 and 1 Mode Register (F8H: Write Only)	75
Figure 51. Interrupt Priority Register (F9H: Write Only)	76
Figure 52. Interrupt Request Register (FAH: Read/Write)	77
Figure 53. Interrupt Mask Register (FBH: Read/Write)	77
Figure 54. Flag Register (FCH: Read/Write)	78
Figure 55. Register Pointer (FDH: Read/Write)	78
Figure 56. Stack Pointer High (FEH: Read/Write)	79
Figure 57. Stack Pointer Low (FFH: Read/Write)	79
Figure 58. 20-Pin CDIP Package	80
Figure 59. 20-Pin PDIP Package Diagram	81
Figure 60. 20-Pin SOIC Package Diagram	81
Figure 61. 20-Pin SSOP Package Diagram	82
Figure 62. 28-Pin CDIP Package	83
Figure 63. 28-Pin SOIC Package Diagram	84
Figure 64. 28-Pin PDIP Package Diagram	85
Figure 65. 28-Pin SSOP Package Diagram	86
Figure 66. 40-Pin CDIP Package	87
Figure 67. 40-Pin PDIP Package Diagram	87
Figure 68. 48-Pin SSOP Package Design	88

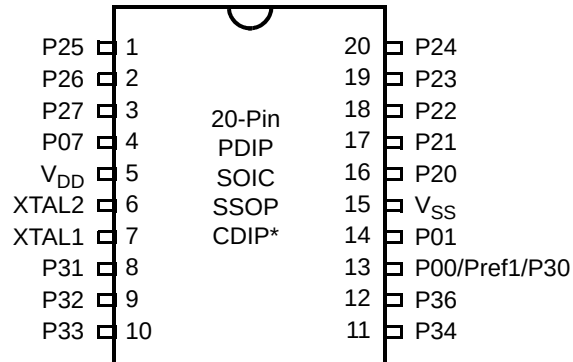


Figure 3. 20-Pin PDIP/SOIC/SSOP/CDIP* Pin Configuration

Table 3. 20-Pin PDIP/SOIC/SSOP/CDIP* Pin Identification

Pin #	Symbol	Function	Direction
1–3	P25–P27	Port 2, Bits 5,6,7	Input/Output
4	P07	Port 0, Bit 7	Input/Output
5	V _{DD}	Power Supply	
6	XTAL2	Crystal Oscillator Clock	Output
7	XTAL1	Crystal Oscillator Clock	Input
8–10	P31–P33	Port 3, Bits 1,2,3	Input
11,12	P34, P36	Port 3, Bits 4,6	Output
13	P00/Pref1/P30	Port 0, Bit 0/Analog reference input Port 3 Bit 0	Input/Output for P00 Input for Pref1/P30
14	P01	Port 0, Bit 1	Input/Output
15	V _{SS}	Ground	
16–20	P20–P24	Port 2, Bits 0,1,2,3,4	Input/Output

► **Note:** *Windowed Cerdip. These units are intended to be used for engineering code development only. ZiLOG does not recommend/guarantee this package for production use.

Absolute Maximum Ratings

Stresses greater than those listed in Table 7 might cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period might affect device reliability.

Table 6. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	0	+70	C	
Storage temperature	−65	+150	C	
Voltage on any pin with respect to V_{SS}	−0.3	+5.5	V	1
Voltage on V_{DD} pin with respect to V_{SS}	−0.3	+3.6	V	
Maximum current on input and/or inactive output pin	−5	+5	μ A	
Maximum output current from active output pin	−25	+25	mA	
Maximum current into V_{DD} or out of V_{SS}		75	mA	

Notes:
This voltage applies to all pins except the following: V_{DD} , P32, P33 and $\overline{\text{RESET}}$.

Standard Test Conditions

The characteristics listed in this product specification apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (see Figure 7).

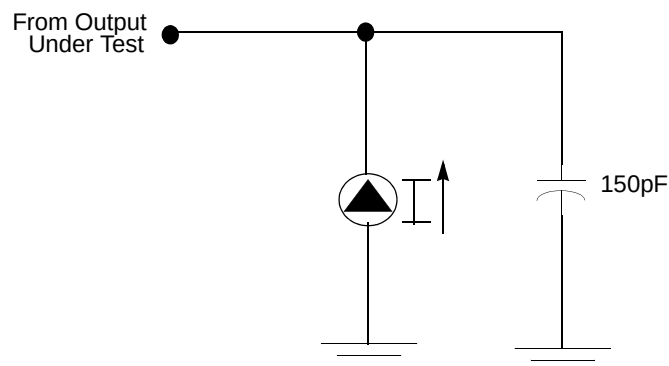


Figure 7. Test Load Diagram

Capacitance

Table 7 lists the capacitances.

Table 7. Capacitance

Parameter	Maximum
Input capacitance	12pF
Output capacitance	12pF
I/O capacitance	12pF
Note: $T_A = 25^\circ\text{C}$, $V_{CC} = \text{GND} = 0\text{V}$, $f = 1.0\text{MHz}$, unmeasured pins returned to GND	

DC Characteristics

Table 8. DC Characteristics

Symbol	Parameter	V_{CC}	$T_A = 0^\circ\text{C to } +70^\circ\text{C}$			Units	Conditions	Notes
			Min	Typ	Max			
V_{CC}	Supply Voltage		2.0		3.6	V	See Note 5	5
V_{CH}	Clock Input High Voltage	2.0-3.6	0.8		$V_{CC}+0.3$	V	Driven by External Clock Generator	
V_{CL}	Clock Input Low Voltage	2.0-3.6	$V_{SS}-0.3$		0.5	V	Driven by External Clock Generator	
V_{IH}	Input High Voltage	2.0-3.6	$0.7 V_{CC}$		$V_{CC}+0.3$	V		
V_{IL}	Input Low Voltage	2.0-3.6	$V_{SS}-0.3$		$0.2 V_{CC}$	V		
V_{OH1}	Output High Voltage	2.0-3.6	$V_{CC}-0.4$			V	$I_{OH} = -0.5\text{mA}$	
V_{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-3.6	$V_{CC}-0.8$			V	$I_{OH} = -7\text{mA}$	
V_{OL1}	Output Low Voltage	2.0-3.6			0.4	V	$I_{OL} = 1.0\text{mA}$ $I_{OL} = 4.0\text{mA}$	
V_{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-3.6			0.8	V	$I_{OL} = 10\text{mA}$	
V_{OFFSET}	Comparator Input Offset Voltage	2.0-3.6			25	mV		
V_{REF}	Comparator Reference Voltage	2.0-3.6	0		V_{DD} -1.75	V		
I_{IL}	Input Leakage	2.0-3.6	-1		1	μA	$V_{IN} = 0\text{V}$, V_{CC} Pull-ups disabled	
I_{OL}	Output Leakage	2.0-3.6	-1		1	μA	$V_{IN} = 0\text{V}$, V_{CC}	
I_{CC}	Supply Current	2.0			10	mA	at 8.0 MHz	1, 2
		3.6			15	mA	at 8.0 MHz	1, 2

Pin Functions

XTAL1 Crystal 1 (Time-Based Input)

This pin connects a parallel-resonant crystal or ceramic resonator to the on-chip oscillator input. Additionally, an optional external single-phase clock can be coded to the on-chip oscillator input.

XTAL2 Crystal 2 (Time-Based Output)

This pin connects a parallel-resonant crystal or ceramic resonant to the on-chip oscillator output.

Port 0 (P07–P00)

Port 0 is an 8-bit, bidirectional, CMOS-compatible port. These eight I/O lines are configured under software control as a nibble I/O port. The output drivers are push-pull or open-drain controlled by bit D2 in the PCON register.

If one or both nibbles are needed for I/O operation, they must be configured by writing to the Port 0 mode register. After a hardware reset, Port 0 is configured as an input port.

An optional pull-up transistor is available as a mask option on all Port 0 bits with nibble select.

- **Notes:** Internal pull-ups are disabled on any given pin or group of port pins when programmed into output mode.

The Port 0 direction is reset to be input following an SMR.

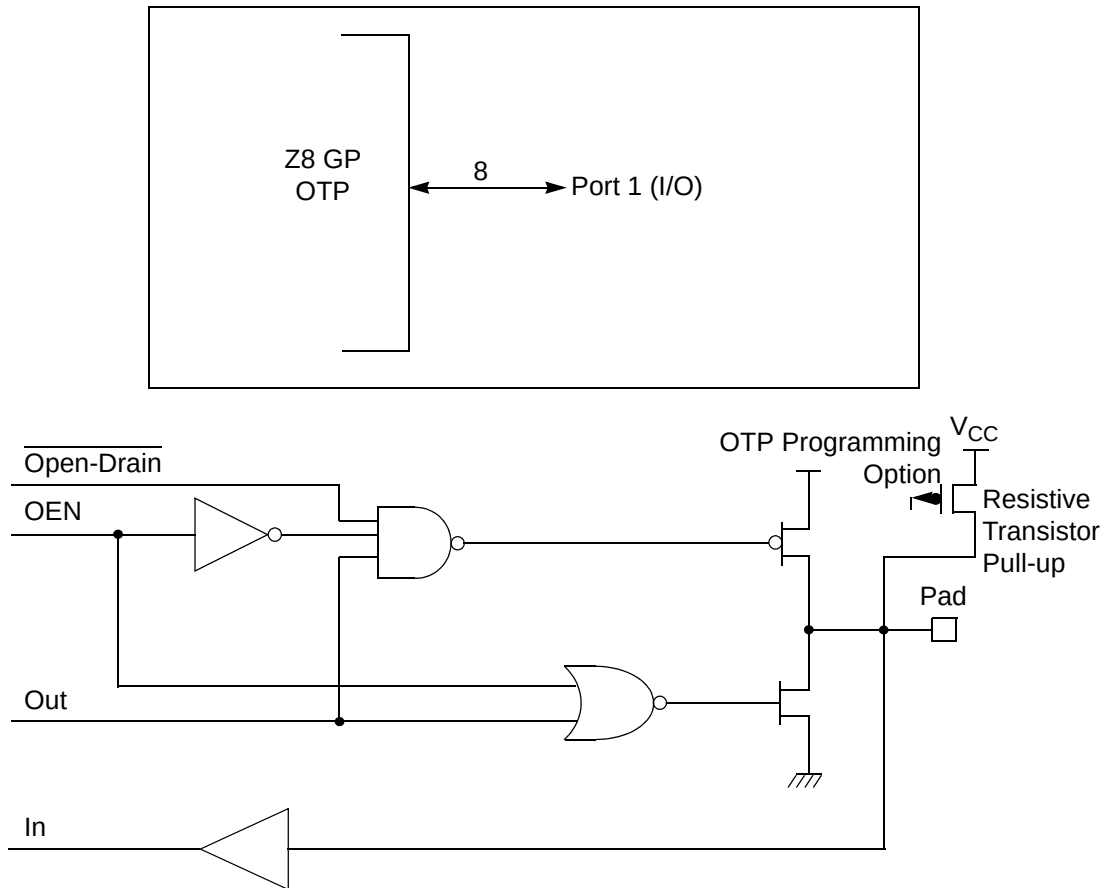


Figure 10. Port 1 Configuration

Port 2 (P27–P20)

Port 2 is an 8-bit, bidirectional, CMOS-compatible I/O port (see Figure 11). These eight I/O lines can be independently configured under software control as inputs or outputs. Port 2 is always available for I/O operation. A mask option is available to connect eight pull-up transistors on this port. Bits programmed as outputs are globally programmed as either push-pull or open-drain. The POR resets with the eight bits of Port 2 configured as inputs.

Port 2 also has an 8-bit input OR and AND gate, which can be used to wake up the part. P20 can be programmed to access the edge-detection circuitry in demodulation mode.

CTR1(0D)01H" on page 33). Other edge detect and IRQ modes are described in Table 11.

- **Note:** Comparators are powered down by entering Stop Mode. For P31–P33 to be used in a Stop Mode Recovery (SMR) source, these inputs must be placed into digital mode.

Table 11. Port 3 Pin Function Summary

Pin	I/O	Counter/Timers	Comparator	Interrupt
Pref1/P30	IN		RF1	
P31	IN	IN	AN1	IRQ2
P32	IN		AN2	IRQ0
P33	IN		RF2	IRQ1
P34	OUT	T8	AO1	
P35	OUT	T16		
P36	OUT	T8/16		
P37	OUT		AO2	
P20	I/O	IN		

Port 3 also provides output for each of the counter/timers and the AND/OR Logic (see Figure 13). Control is performed by programming bits D5–D4 of CTR1, bit 0 of CTR0, and bit 0 of CTR2.

Comparator Inputs

In analog mode, P31 and P32 have a comparator front end. The comparator reference is supplied to P33 and Pref1. In this mode, the P33 internal data latch and its corresponding IRQ1 are diverted to the SMR sources (excluding P31, P32, and P33) as indicated in Figure 12 on page 20. In digital mode, P33 is used as D3 of the Port 3 input register, which then generates IRQ1.

- **Note:** Comparators are powered down by entering Stop Mode. For P31–P33 to be used in a Stop Mode Recovery source, these inputs must be placed into digital mode.

Comparator Outputs

These channels can be programmed to be output on P34 and P37 through the PCON register.

RESET (Input, Active Low)

Reset initializes the MCU and is accomplished either through Power-On, Watch-Dog Timer, Stop Mode Recovery, Low-Voltage detection, or external reset. During Power-On Reset and Watch-Dog Timer Reset, the internally generated reset drives the reset pin Low for the POR time. Any devices driving the external reset line must be open-drain to avoid damage from a possible conflict during reset conditions. Pull-up is provided internally.

When the Z8 GP™ asserts (Low) the RESET pin, the internal pull-up is disabled. The Z8 GP™ does not assert the RESET pin when under VBO.

- **Note:** The external Reset does not initiate an exit from STOP mode.

Functional Description

This device incorporates special functions to enhance the Z8®, functionality in consumer and battery-operated applications.

Program Memory

This device addresses up to 32KB of OTP memory. The first 12 Bytes are reserved for interrupt vectors. These locations contain the six 16-bit vectors that correspond to the six available interrupts.

RAM

This device features 256B of RAM. See Figure 14.

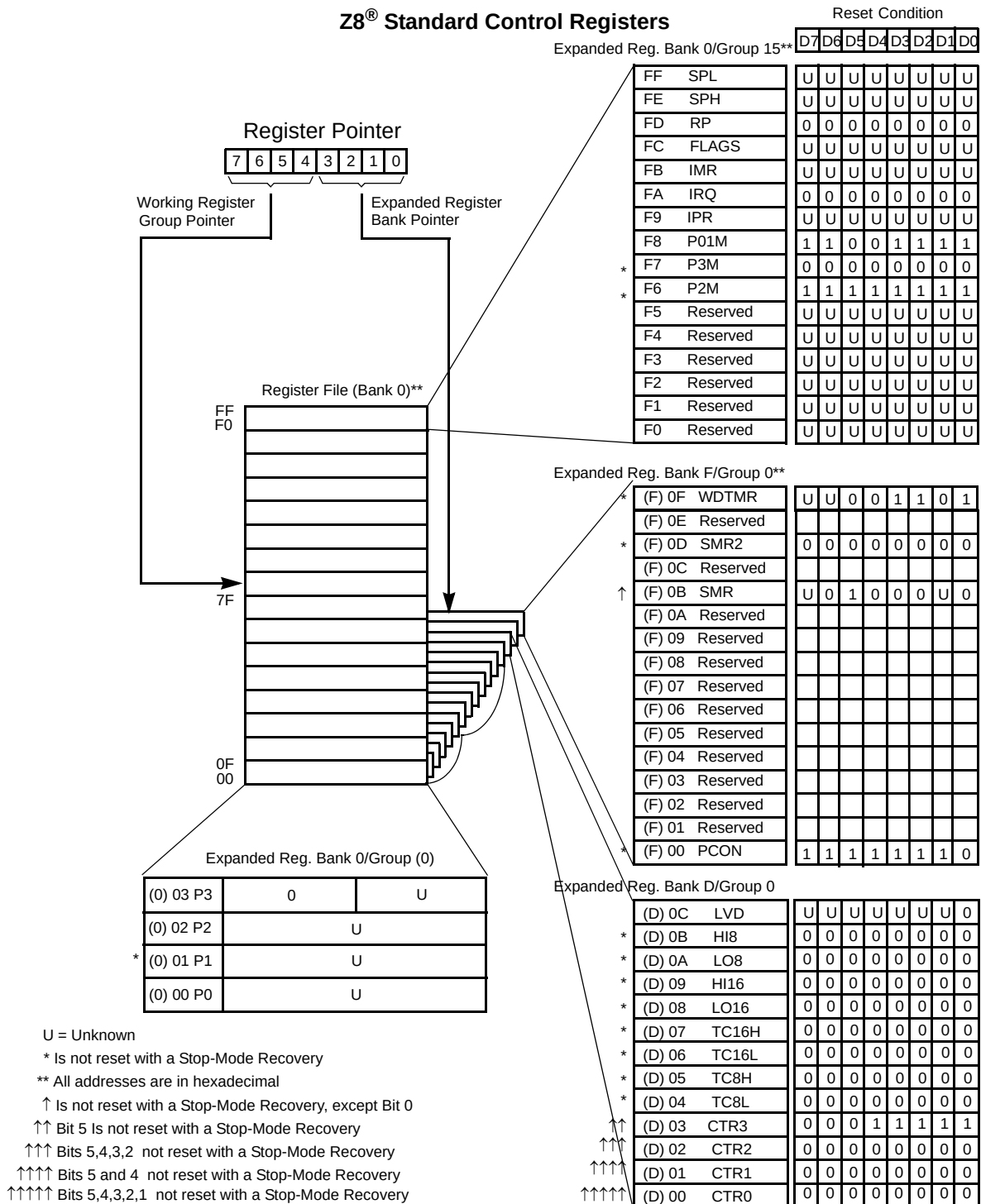


Figure 15. Expanded Register File Architecture

Counter/Timer2 LS-Byte Hold Register—TC16L(D)06H

Field	Bit Position	Description
T16_Data_LO	[7:0]	R/W Data

Counter/Timer8 High Hold Register—TC8H(D)05H

Field	Bit Position	Description
T8_Level_HI	[7:0]	R/W Data

Counter/Timer8 Low Hold Register—TC8L(D)04H

Field	Bit Position	Description
T8_Level_LO	[7:0]	R/W Data

CTR0 Counter/Timer8 Control Register—CTR0(D)00H

Table 12 lists and briefly describes the fields for this register.

Table 12. CTR0(D)00H Counter/Timer8 Control Register

Field	Bit Position		Value	Description
T8_Enable	7-----	R/W	0*	Counter Disabled
			1	Counter Enabled
			0	Stop Counter
			1	Enable Counter
Single/Modulo-N	-6-----	R/W	0	Modulo-N
			1	Single Pass
Time_Out	--5-----	R/W	0	No Counter Time-Out
			1	Counter Time-Out Occurred
			0	No Effect
			1	Reset Flag to 0
T8_Clock	---43---	R/W	0 0	SCLK
			0 1	SCLK/2
			1 0	SCLK/4
			1 1	SCLK/8
Capture_INT_Mask	----2--	R/W	0	Disable Data Capture Interrupt
			1	Enable Data Capture Interrupt

Table 16. Interrupt Types, Sources, and Vectors

Name	Source	Vector Location	Comments
IRQ0	P32	0,1	External (P32), Rising, Falling Edge Triggered
IRQ1	P33	2,3	External (P33), Falling Edge Triggered
IRQ2	P31, T _{IN}	4,5	External (P31), Rising, Falling Edge Triggered
IRQ3	T16	6,7	Internal
IRQ4	T8	8,9	Internal
IRQ5	LVD	10,11	Internal

When more than one interrupt is pending, priorities are resolved by a programmable priority encoder controlled by the Interrupt Priority Register. An interrupt machine cycle activates when an interrupt request is granted. As a result, all subsequent interrupts are disabled, and the Program Counter and Status Flags are saved. The cycle then branches to the program memory vector location reserved for that interrupt. All Z8 GP™ OTP MCU Family interrupts are vectored through locations in the program memory. This memory location and the next byte contain the 16-bit address of the interrupt service routine for that particular interrupt request. To accommodate polled interrupt systems, interrupt inputs are masked, and the Interrupt Request register is polled to determine which of the interrupt requests require service.

An interrupt resulting from AN1 is mapped into IRQ2, and an interrupt from AN2 is mapped into IRQ0. Interrupts IRQ2 and IRQ0 can be rising, falling, or both edge triggered. These interrupts are programmable by the user. The software can poll to identify the state of the pin.

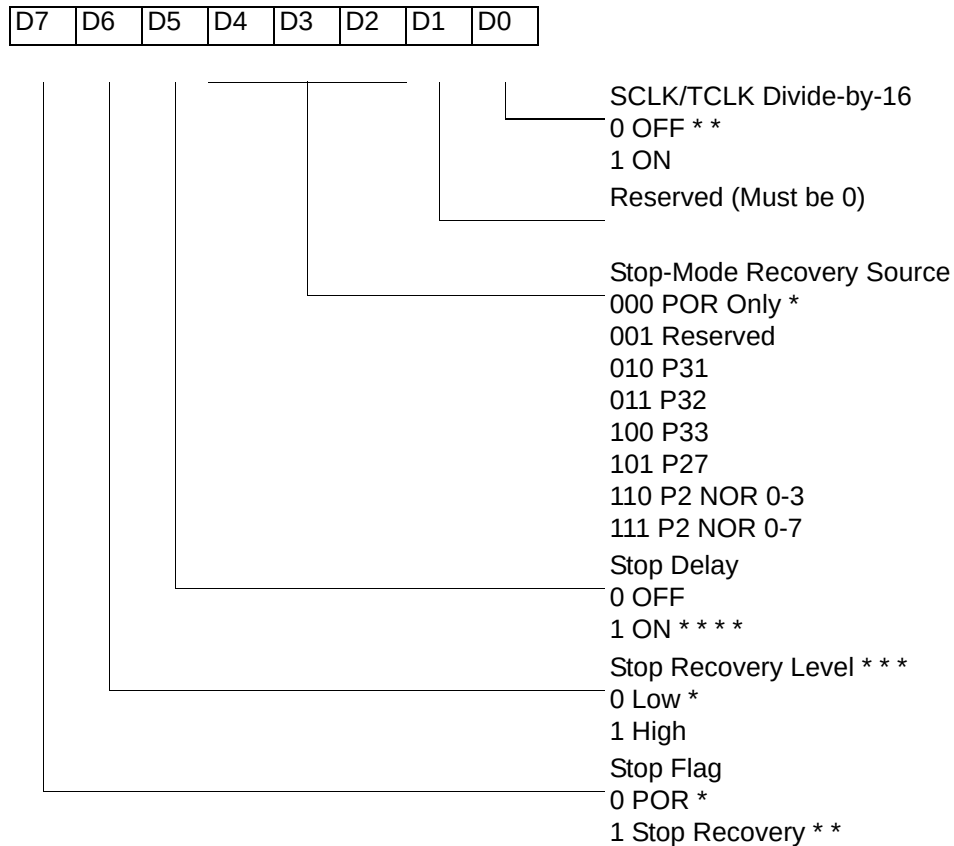
Programming bits for the Interrupt Edge Select are located in the IRQ Register (R250), bits D7 and D6. The configuration is indicated in Table 17.

Table 17. IRQ Register

IRQ		Interrupt Edge	
D7	D6	IRQ2 (P31)	IRQ0 (P32)
0	0	F	F
0	1	F	R
1	0	R	F
1	1	R/F	R/F

Note: F = Falling Edge; R = Rising Edge

SMR(0F)0BH



* Default after Power On Reset or Watch-Dog Reset

** Set after STOP Mode Recovery

*** At the XOR gate input

**** Default setting after reset. Must be 1 if using a crystal or resonator clock source.

Figure 33. STOP Mode Recovery Register

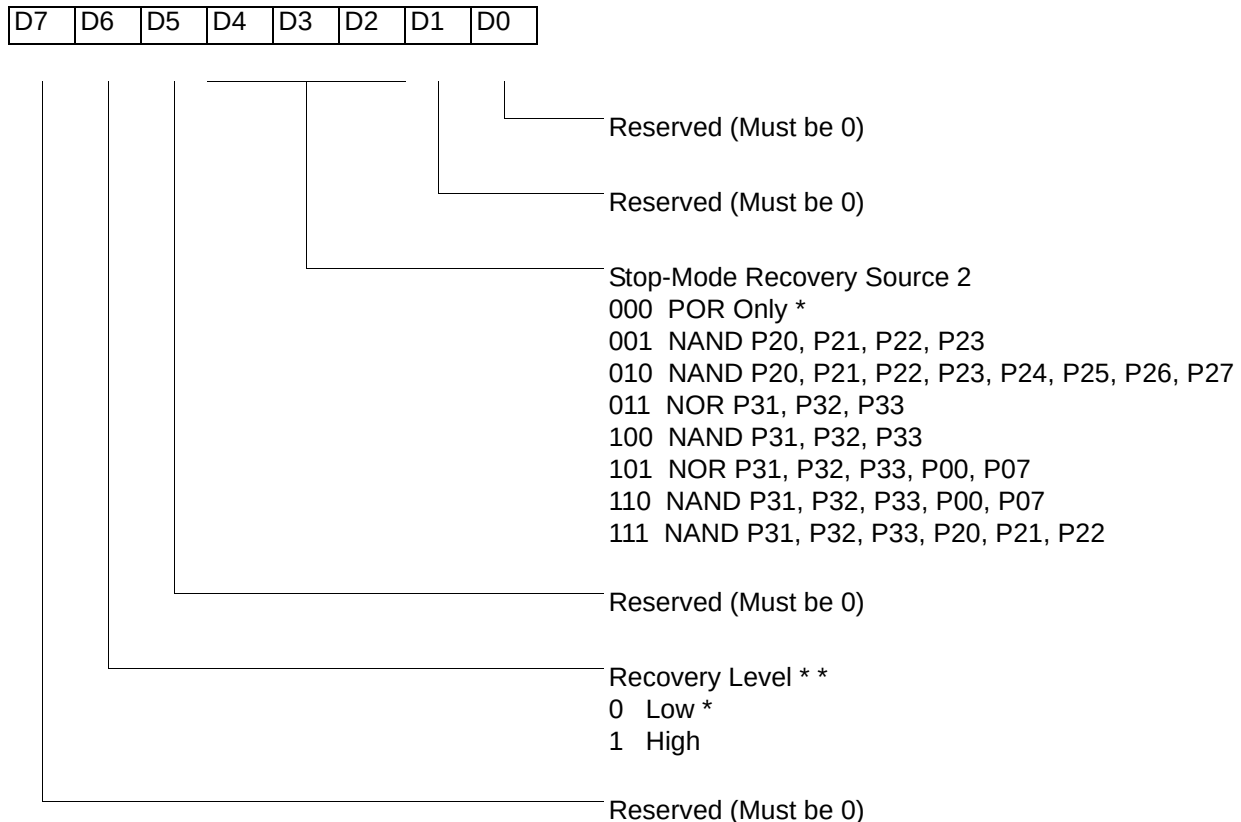
SCLK/TCLK Divide-by-16 Select (D0)

D0 of the SMR controls a divide-by-16 prescaler of SCLK/TCLK (Figure 34). This control selectively reduces device power consumption during normal processor execution (SCLK control) and/or Halt Mode (where TCLK sources interrupt logic). After Stop Mode Recovery, this bit is set to a 0.

Stop Mode Recovery Register 2 (SMR2)

This register determines the mode of Stop Mode Recovery for SMR2 (Figure 36).

SMR2(0F)DH



Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

* Default setting after reset

* * At the XOR gate input

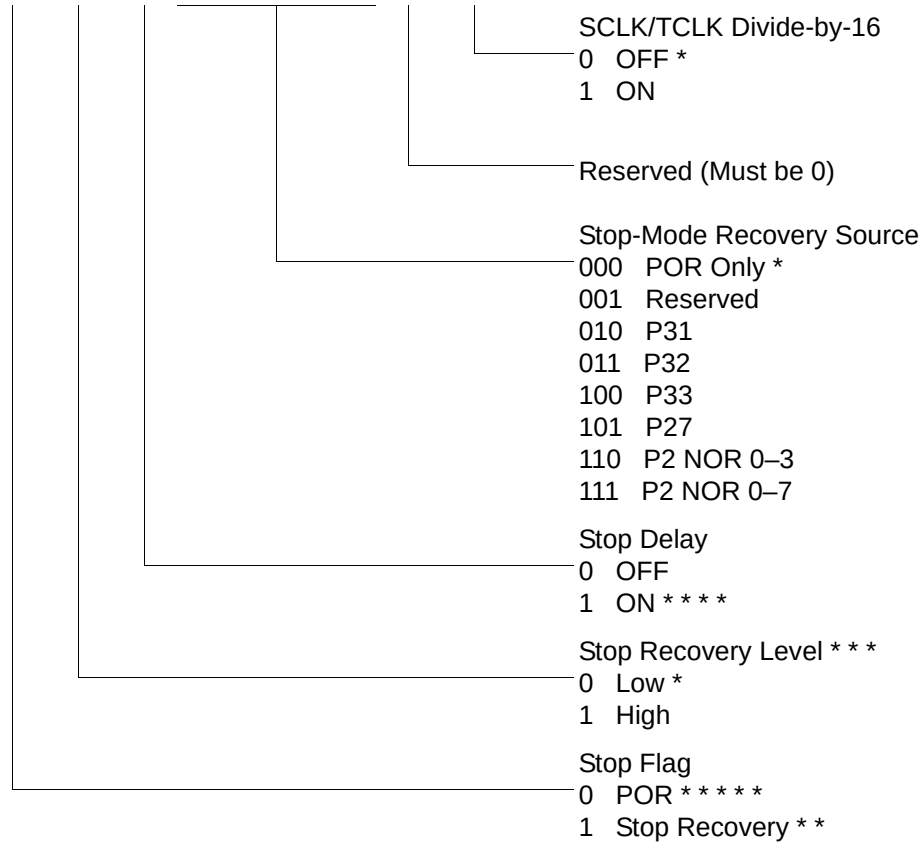
Figure 36. Stop Mode Recovery Register 2 ((0F)DH:D2–D4, D6 Write Only)

If SMR2 is used in conjunction with SMR, either of the specified events causes a Stop Mode Recovery.

- **Note:** Port pins configured as outputs are ignored as an SMR or SMR2 recovery source. For example, if the NAND or P23–P20 is selected as the recovery source and P20 is configured as an output, the remaining SMR pins (P23–P21) form the NAND equation.

SMR(0F)0BH

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



* Default setting after Reset

** Set after STOP Mode Recovery

*** At the XOR gate input

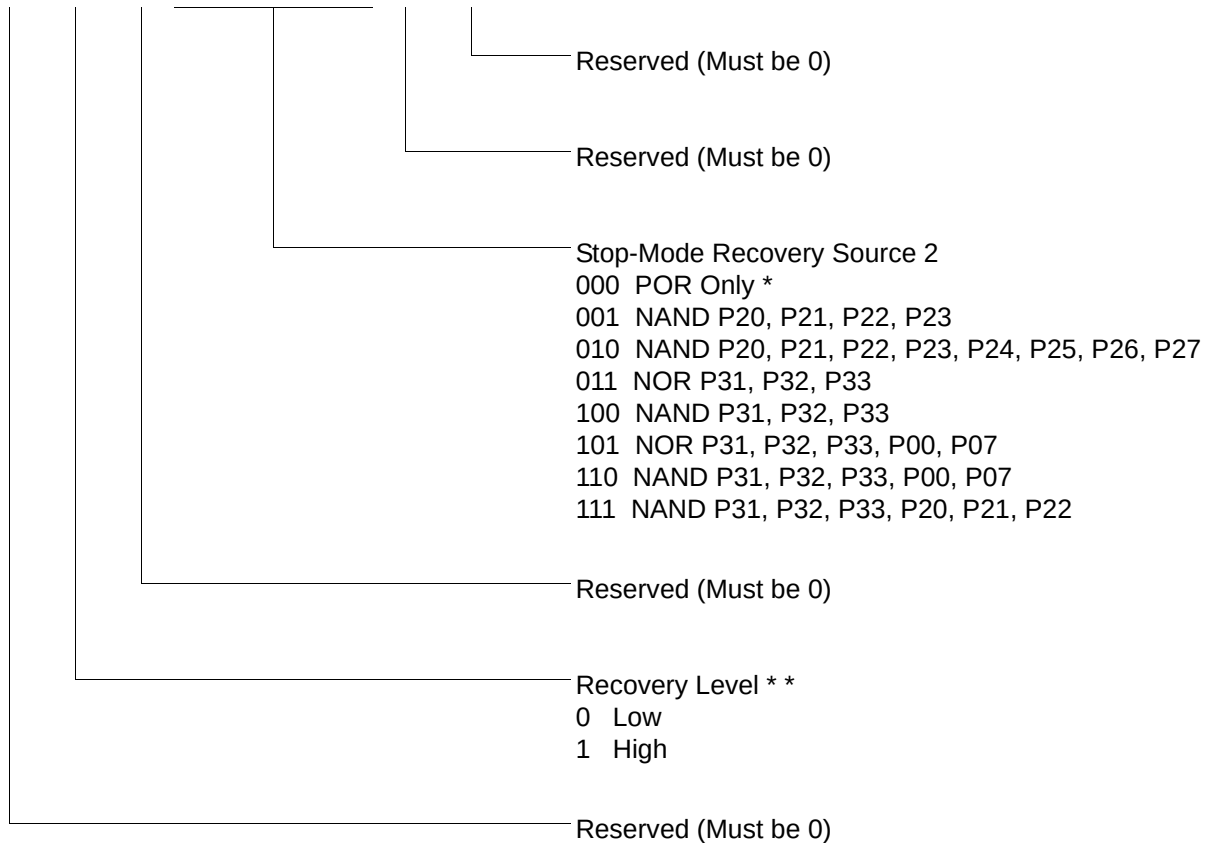
**** Default setting after Reset. Must be 1 if using a crystal or resonator clock source.

***** Default setting after Power On Reset. Not Reset with a Stop Mode recovery.

Figure 45. Stop Mode Recovery Register ((0F)0BH: D6–D0=Write Only, D7=Read Only)

SMR2(0F)0DH

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----



Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

* Default setting after reset

** At the XOR gate input

Figure 46. Stop Mode Recovery Register 2 ((0F)0DH:D2–D4, D6 Write Only)

R254 SPH(FEH)

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----

General-Purpose Register

Figure 56. Stack Pointer High (FEH: Read/Write)

R255 SPL(FFH)

D7	D6	D5	D4	D3	D2	D1	D0
----	----	----	----	----	----	----	----

Stack Pointer Low
Byte (SP7–SP0)

Figure 57. Stack Pointer Low (FFH: Read/Write)

4KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323LSH4804C	48-pin SSOP 4K OTP	ZGP323LSS2804C	28-pin SOIC 4K OTP
ZGP323LSP4004C	40-pin PDIP 4K OTP	ZGP323LSH2004C	20-pin SSOP 4K OTP
ZGP323LSH2804C	28-pin SSOP 4K OTP	ZGP323LSP2004C	20-pin PDIP 4K OTP
ZGP323LSP2804C	28-pin PDIP 4K OTP	ZGP323LSS2004C	20-pin SOIC 4K OTP

4KB Extended Temperature: -40° to +105°C

Part Number	Description	Part Number	Description
ZGP323LEH4804C	48-pin SSOP 4K OTP	ZGP323LES2804C	28-pin SOIC 4K OTP
ZGP323LEP4004C	40-pin PDIP 4K OTP	ZGP323LEH2004C	20-pin SSOP 4K OTP
ZGP323LEH2804C	28-pin SSOP 4K OTP	ZGP323LEP2004C	20-pin PDIP 4K OTP
ZGP323LEP2804C	28-pin PDIP 4K OTP	ZGP323LES2004C	20-pin SOIC 4K OTP

4KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
ZGP323LAH4804C	48-pin SSOP 4K OTP	ZGP323LAS2804C	28-pin SOIC 4K OTP
ZGP323LAP4004C	40-pin PDIP 4K OTP	ZGP323LAH2004C	20-pin SSOP 4K OTP
ZGP323LAH2804C	28-pin SSOP 4K OTP	ZGP323LAP2004C	20-pin PDIP 4K OTP
ZGP323LAP2804C	28-pin PDIP 4K OTP	ZGP323LAS2004C	20-pin SOIC 4K OTP

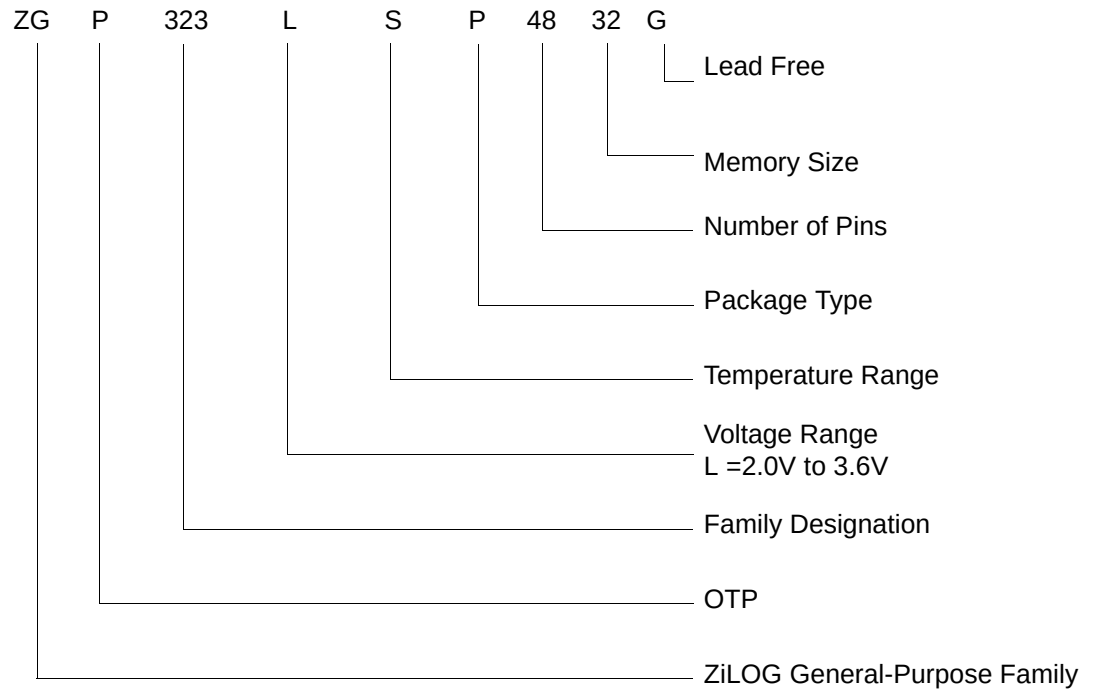
Note: Replace C with G for Lead-Free Packaging

Additional Components

Part Number	Description	Part Number	Description
ZGP323ICE01ZEM	Emulator/programmer	ZGP32300100ZPR	Programming System



Example



Index

Numerics

- 16-bit counter/timer circuits 44
- 20-pin DIP package diagram 81
- 20-pin SSOP package diagram 82
- 28-pin DIP package diagram 85
- 28-pin SOIC package diagram 84
- 28-pin SSOP package diagram 86
- 40-pin DIP package diagram 87
- 48-pin SSOP package diagram 88
- 8-bit counter/timer circuits 40

A

- absolute maximum ratings 10
- AC
 - characteristics 14
 - timing diagram 14
- address spaces, basic 2
- architecture 2
 - expanded register file 26

B

- basic address spaces 2
- block diagram, ZLP32300 functional 3

C

- capacitance 11
- characteristics
 - AC 14
 - DC 11
- clock 51
- comparator inputs/outputs 23
- configuration
 - port 0 17
 - port 1 18
 - port 2 19
 - port 3 20
 - port 3 counter/timer 22

counter/timer

- 16-bit circuits 44
- 8-bit circuits 40
- brown-out voltage/standby 62
- clock 51
- demodulation mode count capture flow-chart 42
- demodulation mode flowchart 43
- EPROM selectable options 62
- glitch filter circuitry 38
- halt instruction 52
- input circuit 38
- interrupt block diagram 49
- interrupt types, sources and vectors 50
- oscillator configuration 51
- output circuit 47
- ping-pong mode 46
- port configuration register 53
- resets and WDT 61
- SCLK circuit 56
- stop instruction 52
- stop mode recovery register 55
- stop mode recovery register 2 59
- stop mode recovery source 57
- T16 demodulation mode 45
- T16 transmit mode 44
- T16_OUT in modulo-N mode 45
- T16_OUT in single-pass mode 45
- T8 demodulation mode 41
- T8 transmit mode 38
- T8_OUT in modulo-N mode 41
- T8_OUT in single-pass mode 41
- transmit mode flowchart 39
- voltage detection and flags 63
- watch-dog timer mode register 60
- watch-dog timer time select 61
- CTR(D)01h T8 and T16 Common Functions 33